

HD74LS161A

Synchronous 4-bit Binary Counter (direct clear)

REJ03D0445-0200 Rev.2.00 Feb.18.2005

This synchronous 4-bit binary counter features an internal carry look-ahead for application in high-speed counting designs. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs changes coincident with each other when so instructed by the count-enable inputs and internal gating. This mode is operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters. A buffered clock input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform. This counter is fully programmable; that is, the output may be preset to either level. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse regardless of the levels of the enable inputs. Low-to-high transitions at the load input should be avoided when the clock is low if the enable inputs are high at or before the transition. The clear function is asynchronous and a low level at the clear input sets all four of the flip-flop outputs low regardless of the levels of clock, load, or enable inputs. The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional getting. Instrumental in accomplishing this function are two count-enable inputs and a ripple carry output. Both count-enable inputs (P and T) must be high to count, and input T is fed forward to enable the ripple carry output. The ripple carry output thus enabled will produced a high-level output pulse with a duration approximately equal to the high-level portion of the Q_A output. This high-level overflow ripple carry pulse can be used to enable successive cascaded stages. High-to-low-level transitions at the enable P or T inputs should occur only when the clock input is high.

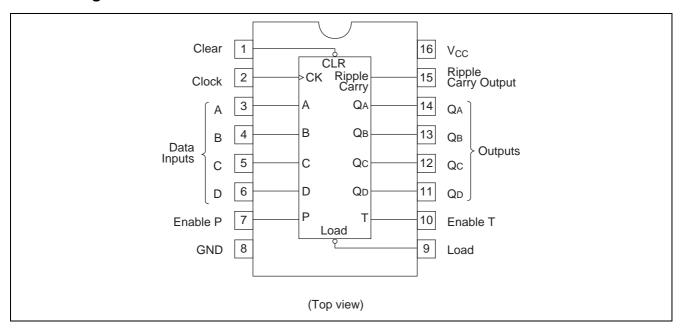
Features

• Ordering Information

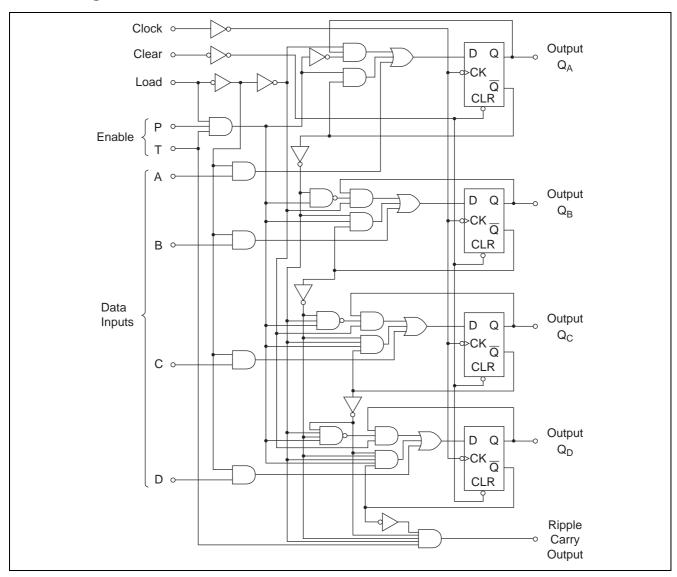
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS161AP	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74LS161AFPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)
HD74LS161ARPEL	SOP-16 pin (JEDEC)	PRSP0016DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Block Diagram



Absolute Maximum Ratings

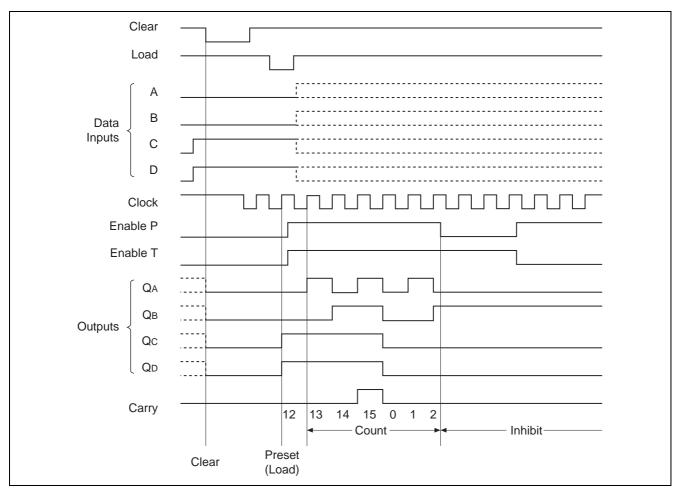
Item	Symbol	Ratings	Unit
Supply voltage	V _{CC}	7	V
Input voltage	V _{IN}	7	V
Power dissipation	P _T	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item		Symbol	Min	Тур	Max	Unit
Supply voltage		V _{CC}	4.75	5.00	5.25	V
Output current	0.45.4		_	_	-400	μΑ
Output current		I _{OL}	_	_	8	mA
Operating temperature		Topr	-20	25	75	°C
Clock frequency		f_{clock}	0	_	25	MHz
Clock pulse width	Clock pulse width		25	_	_	ns
Clear pulse width		t _{w (clear)}	20	_	_	ns
	A, B, C, D		20	_	_	ns
Setup time Enable P, T		t _{su}	20	_	_	ns
	Load		20	_	_	ns
Hold time		t _h	3	_	_	ns

Typical Clear, Preset, and Inhibit Sequence



Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

Item		Symbol	min.	typ.*	max.	Unit	Condition	
Input voltage		V _{IH}	2.0			V		
iriput voi	lage	V_{IL}			0.8	V		
Quitout			2.7			V	$V_{CC} = 4.75 \; V, V_{IH} = 2 \; V, V_{IL} = 0.8 \; V, \\ I_{OH} = -400 \; \mu A$	
Output v	ollage	V	_	_	0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$	
		V_{OL}			0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$	
	Data, Enable P				20			
	Load, Clock, Enable T	I _{IH}			40	μΑ	$V_{CC} = 5.25 \text{ V}, V_{I} = 2.7 \text{ V}$	
	Clear				20			
lanut	Data, Enable P		_	_	-0.4			
Input current	Load, Clock, Enable T	I _{IL}	_	_	-0.8	mA	$V_{CC} = 5.25 \text{ V}, V_{I} = 0.4 \text{ V}$	
Current	Clear		_		-0.4			
	Data, Enable P		_	_	0.1			
	Load, Clock, Enable T	I _I	_	_	0.2	mA	$V_{CC} = 5.25 \text{ V}, V_{I} = 7 \text{ V}$	
	Clear		_	_	0.1			
Short-circuit output current		los	-20	_	-100	mA	V _{CC} = 5.25 V	
Supply current**		Іссн	_	18	31	mA	V _{CC} = 5.25 V	
		I _{CCL}		19	32	mA	V _{CC} = 5.25 V	
Input cla	mp voltage	V _{IK}	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$	

Notes: $^*V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$

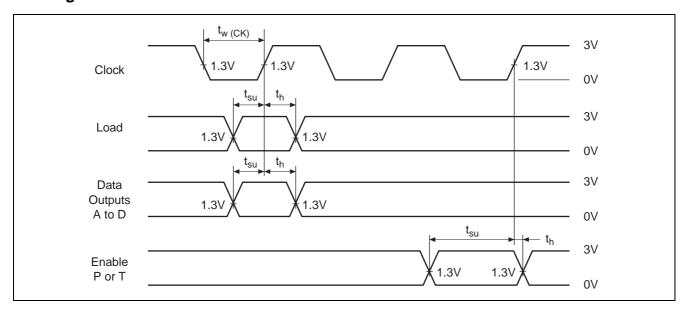
Switching Characteristics

 $(V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C})$

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	$f_{\sf max}$	Clock	Q _A to Q _D	25	32	_	MHz	
	t _{PLH}	Clock	Ripple		20	35	ns	
	t _{PHL}	CIOCK	Carry		18	35	ns	
	t _{PLH}	Clock	Q _A to Q _D	_	13	24	ns	
	t _{PHL}	(Load = "H")		_	18	27	ns	$C_L = 15 pF$,
Propagation delay time	t _{PLH}	Clock	Q _A to Q _D	_	13	24	ns	$R_L = 2 k\Omega$
	t _{PHL}	(Load = "L")	QA IO QD	_	18	27	ns	
	t _{PLH}	Enable T	Ripple Carry	_	9	14	ns	
	t _{PHL}	Lilable		_	9	14	ns	
	t _{PHL}	Clear	Q _A to Q _D	_	20	28	ns	

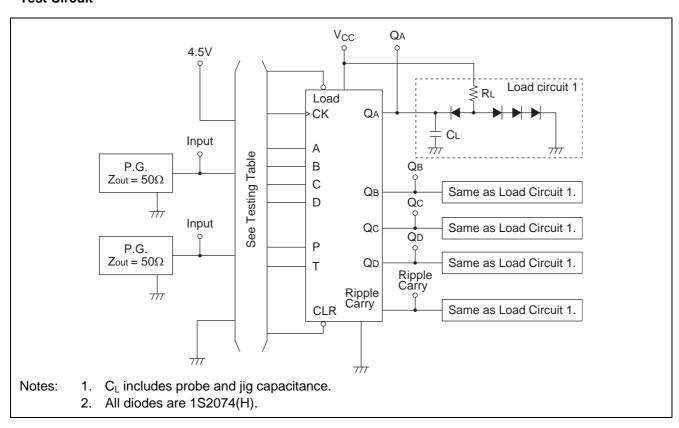
^{**} I_{CCH} is measured with the load input high, then again with the load input low, with all other inputs high and all outputs open. I_{CCL} is measured with the clock input high, then again with the clock input low, with all other inputs low and all outputs open.

Timing Method



Testing Method

Test Circuit



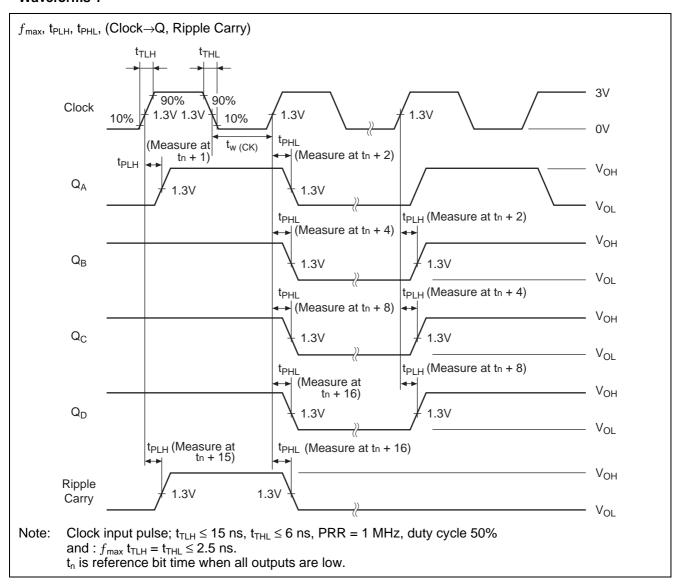
Testing Table

Item	Francisco de	Inputs									
	From input to output	Clear	Lood	Ena	Enable		Data				
	Output	Clear	Load	Р	Т	Clock	Α	В	С	D	
$f_{\sf max}$		4.5V	4.5V	4.5V	4.5V	IN	GND	GND	GND	GND	
	CK Ripply → Carry	4.5V	4.5V	4.5V	4.5V	IN	GND	GND	GND	GND	
	$CK \to Q$	4.5V	4.5V	4.5V	4.5V	IN	GND	GND	GND	GND	
t _{PLH}	$CK \to Q$	4.5V	GND	GND	GND	IN	IN*	IN*	IN*	IN*	
t _{PHL}	$\begin{array}{ccc} \text{Enable} & \to & \text{Ripple} \\ \text{T} & \to & \text{Carry} \end{array}$	4.5V	GND	4.5V	IN	IN*	4.5V	4.5V	4.5V	4.5V	
	$CLR \to Q$	IN	GND	GND	GND	IN*	4.5V	4.5V	4.5V	4.5V	

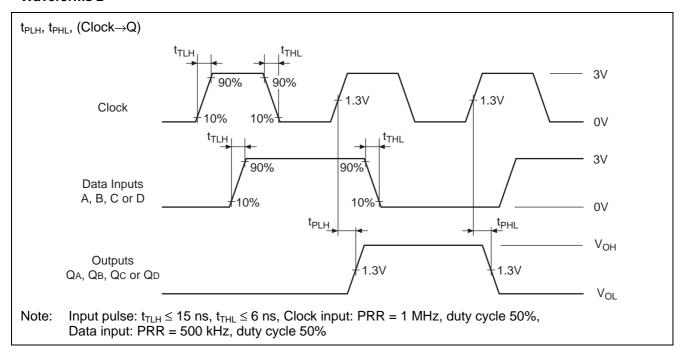
Notes: *. For initialized

Item	From input to output	Outputs								
	From input to output	Q_A	Q_{B}	Q _C	Q_D	Ripple Carry				
$f_{\sf max}$		OUT	OUT	OUT	OUT	OUT				
	CK→Ripple Carry	_	_	_	_	OUT				
4	CK→Q	OUT	OUT	OUT	OUT	_				
t _{PLH}	CK→Q	OUT	OUT	OUT	OUT	_				
t _{PHL}	Enable T→Ripple Carry	_	_	_	_	OUT				
	CLR→Q	OUT	OUT	OUT	OUT	_				

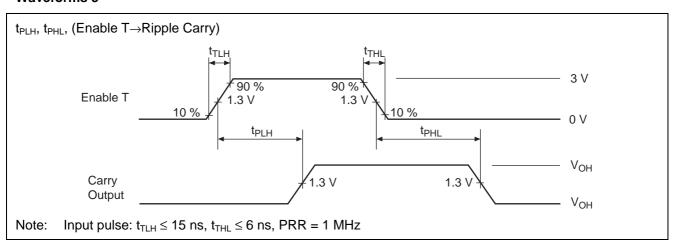
Waveforms 1



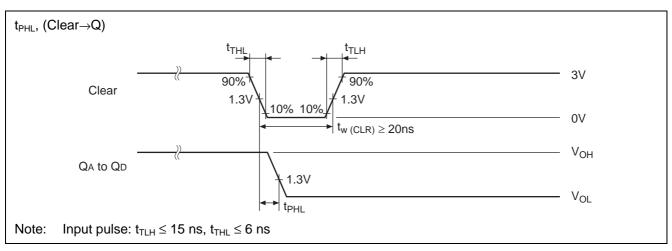
Waveforms 2



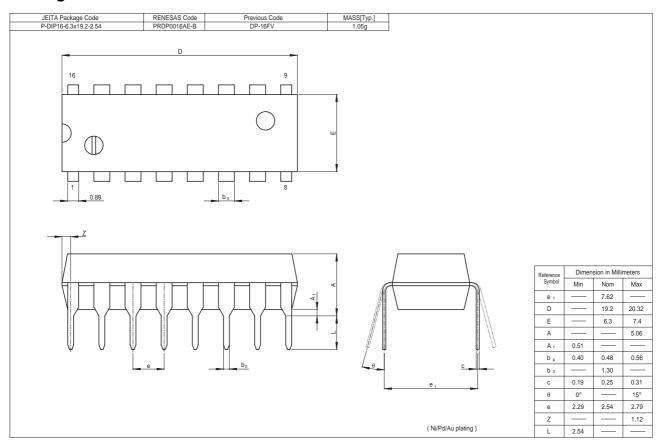
Waveforms 3

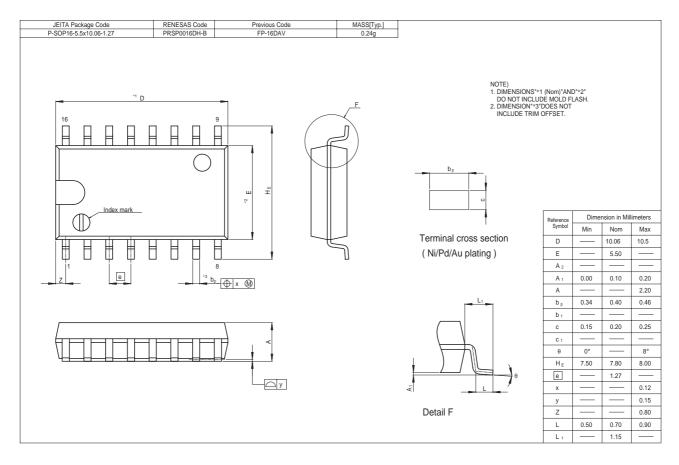


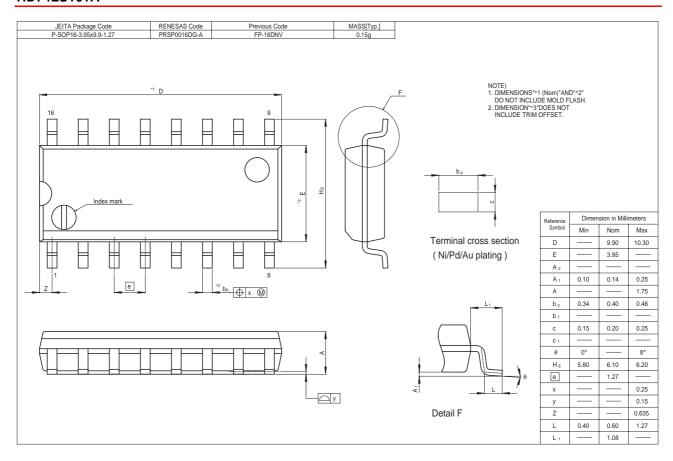
Waveforms 4



Package Dimensions







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